HORIZON EUROPE PROGRAMME

TOPIC HORIZON-CL5-2021-D3-03

Demonstration pilot lines for alternative and innovative PV technologies (Novel c-Si tandem, thin film tandem, bifacial, CPV, etc.)

GA No. 101084046

Digitalised pilot lines for silicon heterojunction tunnel interdigitated back contact solar cells and modules



PILATUS - Deliverable report

D4.2 Draft with first results from Inline Cell and Module Metrology





Deliverable No.	PILATUS D4.2 (R/SEN)	
Related WP	WP4	
Deliverable Title	Draft with first results from Inline Cell and Module Metrology	
Deliverable Date	2024-10-31	
Deliverable Type	REPORT	
Dissemination level	Sensitive – member only (SEN)	
Author(s)	Atse Louwen (EURAC)	
	Claude Sanz (PASAN)	
	Rainer Grischke (MBCH)	
	Martin Ledinsky (FZU)	
	Christopher Berge (ISRA)	
	Marko Turek (Fraunhofer CSP)	
Checked by	Atse Louwen (EURAC)	2024-10-16
Reviewed by (if applicable)	Martin Ledinsky (FZU)	2024-10-18
Approved by	Anna Molinari (UNR) – Project coordinator	2024-10-22
Status	Final version	2024-10-22

Document History:

Version	Date	Editing done by	Remarks
V01	05/09/2024	Marko Turek	Setup document structure
V02	11/10/2024	Marko Turek	Alignment of partner's input
V03	16/10/2024	Atse Louwen	Checked by WP leader
V04	21/10/2024	Martin Ledinsky	Review
V05	22/10/2024	Anna Molinari	Final review

Deliverable Background:

Based on task T4.1 (Definition of indoor and outdoor measurement and testing protocol), the task T4.2 aims at the investigation of possibilities and requirements for an inline metrology in the cell pilot line (WP2) and module pilot line (WP3). The focus is on the development of novel inline metrology tools and procedures for the IBC tunnel SHJ technology. Several project partners contribute to this deliverable. ISRA develops inline metrology systems suitable for inspection of SHJ tunnel-IBC cells. FhG implements new measurement applications in automated test platforms to evaluate inline applicability, e.g. for LED sun simulators in combination with imaging techniques. FZU is investigating advanced inspection techniques for structured contacts using Raman or PL-imaging. PASAN develops an inline I-V-measurement unit with special focus on a reliable contacting unit. MBCH focusses on the implementation and data analysis of inline metrology in the module pilot line.



Publishable summary

The aim of PILATUS's work package 4 is to ensure and assess the quality of the solar PV modules. Therefore, the silicon heterojunction (SHJ) tunnel-interdigitated back contact (IBC) solar cells and modules are to be tested extensively, and the results are thoroughly evaluated. This deliverable represents a draft with first results from Inline Cell and Module Metrology. By collecting these data along the pilot line processes, a continuous evaluation of cells, cell processes and module components will provide ongoing feedback in the development of the components. Given the high throughputs of the cell and module pilot lines, and the correspondingly large dataflows generated from inline metrology equipment, smart approaches are needed to collect and store only the relevant data.

Within the tasks on metrology and reliability of SHJ tunnel-IBC technology, requirements and technological solutions for an inline characterization of cells and modules are investigated and developed. For the cell metrology, it focusses on reliable I-V-measurements, spectral luminescence imaging, and optical inspection. A reliable contacting solution, applicable to the IBC metallization layout, is crucial for inline metrology. Within the project, several configurations are developed, tested and scaled to recent cell sizes by PASAN. This contacting solution is integrated into an automated measurement unit and evaluated by FhG-CSP regarding measurement errors and its usage for more advanced characterization such as thermography or light beam induced current measurement. FZU, FhG-CSP and ISRA furthermore develop imaging solution with inline applicability. ISRA reports on advances in the implementation of a new image analysis algorithm to identify print and alignment defects. FZU has developed photoluminescence-based imaging for visualization of non-uniformities in the deposited passivation and/or back-contact layers. FhG-CSP has performed tests to integrated spectral PL imaging into its automated lab-to-fab platform. Besides the metrology techniques themselves, adapted data collection and data analysis is developed, for example innovative algorithms for the image analysis during optical inspection.

The module pilot line contains several camera-based inspection systems for process control in open and closed loops. The highest precision of component alignment is essential for faultless IBC string and module production. Key components like the foil-wire-assembly (FWA) production on the Roll-to-Roll Unit (RRU) and the string production on the Cell-Connecting-Station (CCS) are monitored carefully. Crack inspection systems developed by Meyer Burger are combined with predictive maintenance concepts programmed by CSEM. The back-end focusses on standard inline metrology including visual imagery, electroluminescence imaging, and current voltage characteristics with respect to tunnel-IBC specific characteristics. All metrology data of the module pilot line can be stored in the MES for future analysis and module performance tracing.



6 Acknowledgement

The author(s) would like to thank the partners in the project for their valuable comments on previous drafts and for performing the review.

Project partners:

rioject partilers.				
#	Partner	Partner Full Name		
	short name			
1	UNR	Uniresearch BV		
2	MBG	Meyer Burger (Germany) GmbH		
3	MBI	Meyer Burger (Industries) GmbH		
4	FhG	Fraunhofer Gesellschaft zur Forderung der Angewandten Forschung EV		
5	FZU	Fyzikalni Ustav AV CR V.V.I		
6	EURAC	Accademia Europea di Bolzano		
7	EXATEQ	Exateq GmbH		
8	TNO	Nederlandse Organisatie Voor Toegepast Natuurwetenschappelijk Onderzoek		
		TNO		
9	NCR	Norwegian Crystals AS (terminated)		
10	ULIEGE	Universite de Liege		
11	PADA	Finproject SpA		
12	ISRA	ISRA VISION GmbH		
13	CSEM	CSEM Centre Suisse d'Eletronique et de Microtechnique SA – Recherche et		
		Developpement		
14	МВСН	Meyer Burger AG		
15	MBR	Meyer Burger Research AG		
16	PASAN	PASAN SA		
17	WCH	Wacker Chemie AG		
18	EPFL	École Polytechnique Fédérale de Lausanne		
19	СРТ	Cambridge Photon Technology Limited		
20	NOR	Norsun AS		

Disclaimer/ Acknowledgment



Copyright ©, all rights reserved. This document or any part thereof may not be made public or disclosed, copied or otherwise reproduced or used in any form or by any means, without prior permission in writing from the PILATUS Consortium. Neither the PILATUS Consortium nor any of its members, their officers, employees or agents shall be liable or responsible, in negligence or otherwise, for any loss, damage or

expense whatever sustained by any person as a result of the use, in any manner or form, of any knowledge, information or data contained in this document, or due to any inaccuracy, omission or error therein contained.

All Intellectual Property Rights, know-how and information provided by and/or arising from this document, such as designs, documentation, as well as preparatory material in that regard, is and shall remain the exclusive property of the PILATUS Consortium and any of its members or its licensors. Nothing contained in this document shall give, or shall be construed as giving, any right, title, ownership, interest, license or any other right in or to any IP, know-how and information.

This project has received funding from the European Union's Horizon Europe research and innovation programme under grant agreement No 101084046. Views and opinions expressed are however those of the author(s) only and do not necessarily reflect those of the European Union. Neither the European Union nor the granting authority can be held responsible for them.